

MER3-533-134X2M-SWIR F02

MERCURY3 5MP CMOS CXP2.0 SWIR Camera









The MER3-533-134X2M-SWIR F02 camera is equipped with Sony IMX992 global shutter sensor and uses CoaXPress2.0 interface for high-speed transmission of image data, featuring high quality images, extremely low power, small housing, and stable operating capability. The camera is capable of 12.5Gbit/s maximum transfer data rate, support PoCXP and can secure the reliability of cameras deployed in harsh industrial environments. The cameras are industrial cameras with high reliability, high transmission speed and high image quality.

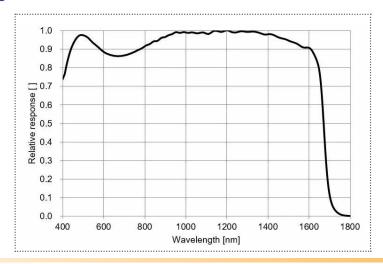
Applications

Suitable for applications such as wafer inspection, AOI inspection, spots inspection, medical inspection and so on.

Features

- Static Defect Pixel Correction: correct sensor defect pixels, freely added or deleted defect pixels coordinates
- The Sequencer Control supports multiple sets of parameters configuration
- Hot Pixel Correction, Sharpness, Noise Reduction, Black Level, User Set Control, Timer and Counter
- Brightness, Contrast, Gamma, LUTs
- DAHENG IMAGING or third-party frame grabbers are available

Spectral Response





Specifications

| Model | MER3-533-134X2M-SWIR F02 |
|-----------------------------|---|
| Resolution | 2592(H) × 2056(V) |
| Sensor | Sony IMX992 Global shutter CMOS |
| Sensor Format | 1/1.4" |
| Pixel Size | 3.45μm × 3.45μm |
| Frame Rate | 134.12fps |
| ADC | 8 bit, 10 bit, 12 bit |
| Pixel Bit Depth | 8 bit, 10 bit, 12 bit |
| Mono/Color | Mono, SWIR |
| Pixel Formats | Mono8 / Mono10 / Mono12 |
| SNR | 46.245 dB |
| Exposure Time | UltraShort: 6μs ~ 26μs, Actual Steps: 1μs; Standard: 27μs ~ 1s, Actual Steps: 1μs |
| Gain | Digital Gain: 0dB~16dB, Default: 0dB, Steps: 0.1dB |
| Binning | - |
| Decimation | Sensor: 1×1, 2×2 |
| Synchronization | Hardware trigger, software trigger |
| Acquisition Mode | Single frame, Continuous, Software trigger, Hardware trigger, CXP trigger |
| Reverse X/Y | Reverse X/Y |
| I/O Interface | 1 input with opto-isolated, 2 programmable GPIOs |
| Data Interface | CXP-12 × 1 (HDBNC) |
| Power Supply | PoCXP |
| Power Consumption | 4.0 W @ PoCXP |
| Operating Temp. | 0°C ~ +45°C |
| Storage Temp. | -20°C ~ +70°C |
| Operating Humidity | 10% ~ 80% |
| Lens Mount | С |
| Filters / Transparent Glass | - |
| Dimensions | 29mm × 29mm × 34mm (without lens adapter or connectors) |
| Weight | 60 g |
| Software | DAHENG IMAGING or third-party frame grabbers supporting software |
| os | Win7 / Win8 / Win10 / Win11 |
| Conformity | CE, RoHS, FCC, ICES, UKCA, CoaXPress2.0, GenlCam |

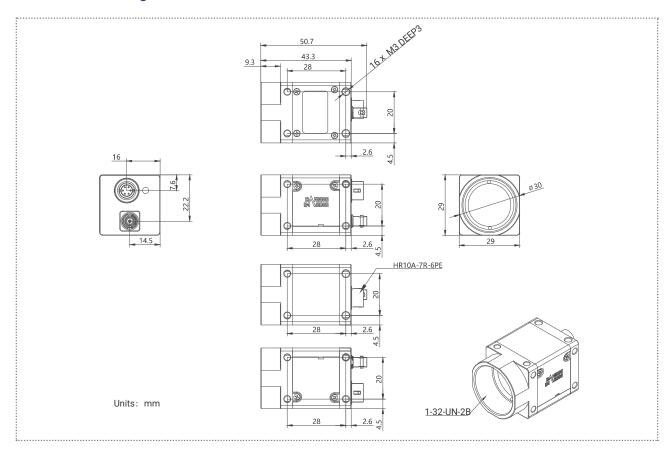


I/O Interface



| Pin | Definition | Description |
|-----|------------|-----------------------|
| 1 | _ | _ |
| 2 | Line0+ | Opto-isolated input + |
| 3 | Line2 | GPIO0 input/output |
| 4 | Line3 | GPIO1 input/output |
| 5 | Line0- | Opto-isolated input - |
| 6 | GND | PWR GND & GPIO GND |

Technical Drawing



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